



**BRIGHTTEK**  
**BRIGHTTEK (EUROPE) LIMITED**

*Brighten up The World With LED!*



ISO/TS 16949:2009



BS EN ISO 14001:2004



QC 080000 IECQ HSPM

## PRODUCT DATASHEET



- ▶ PLCC2
- ▶ K1 Series
- ▶ Blue (460-470nm)

NOB06S20 (Tube)  
 NOB06S20RL (Reel)



Release Date: 27 May 2019 Version: A1.2



K1 Series

### K1 Series



#### FEATURES:

- **Package:** PLCC White SMT Package
- **Forward Current:** 350mA
- **Forward Voltage (typ.):** 3.2V
- **Luminous Flux (typ.):** 40lm@350mA
- **Colour:** Blue
- **Wavelength:** 460-470nm
- **Viewing angle:** 155°
- **Materials:**
  - Die: InGaN
  - Resin: Silicon (Water Clear)
- **Operating Temperature:** -30~+100°C
- **Storage Temperature:** -40~+120°C
- **Grouping parameters:**
  - Forward voltage
  - Luminous flux
  - Wavelength
- **Soldering methods:** Reflow soldering
- **Preconditioning:** acc. to JEDEC Level 3
- **Packing:** 2000pcs/carton (40 tubes); 50pcs/tube  
 24mm tape with 1000pcs/reel, ø330mm (13")

#### APPLICATIONS:

- General Lighting
- Commercial Lighting
- Residential Lighting
- Architectural Lighting
- Flash Lighting
- Reading Lights

## CHARACTERISTICS:

### Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	$I_F$	350	mA
Peak Forward Current Duty 1/10@10KHz	$I_{FP}$	500	mA
Operating Temperature	$T_{OPR}$	-30~+100	°C
Storage Temperature	$T_{STG}$	-40~+120	°C
Junction Temperature	$T_j$	110	°C
Temperature Coefficient of VF	$\Delta V_F/\Delta T_j$	-2	mV/°C
Thermal Resistance Junction to Lead	$T_{junction-lead}$	12	°C/W

1. Not suitable to be driven in reverse bias.

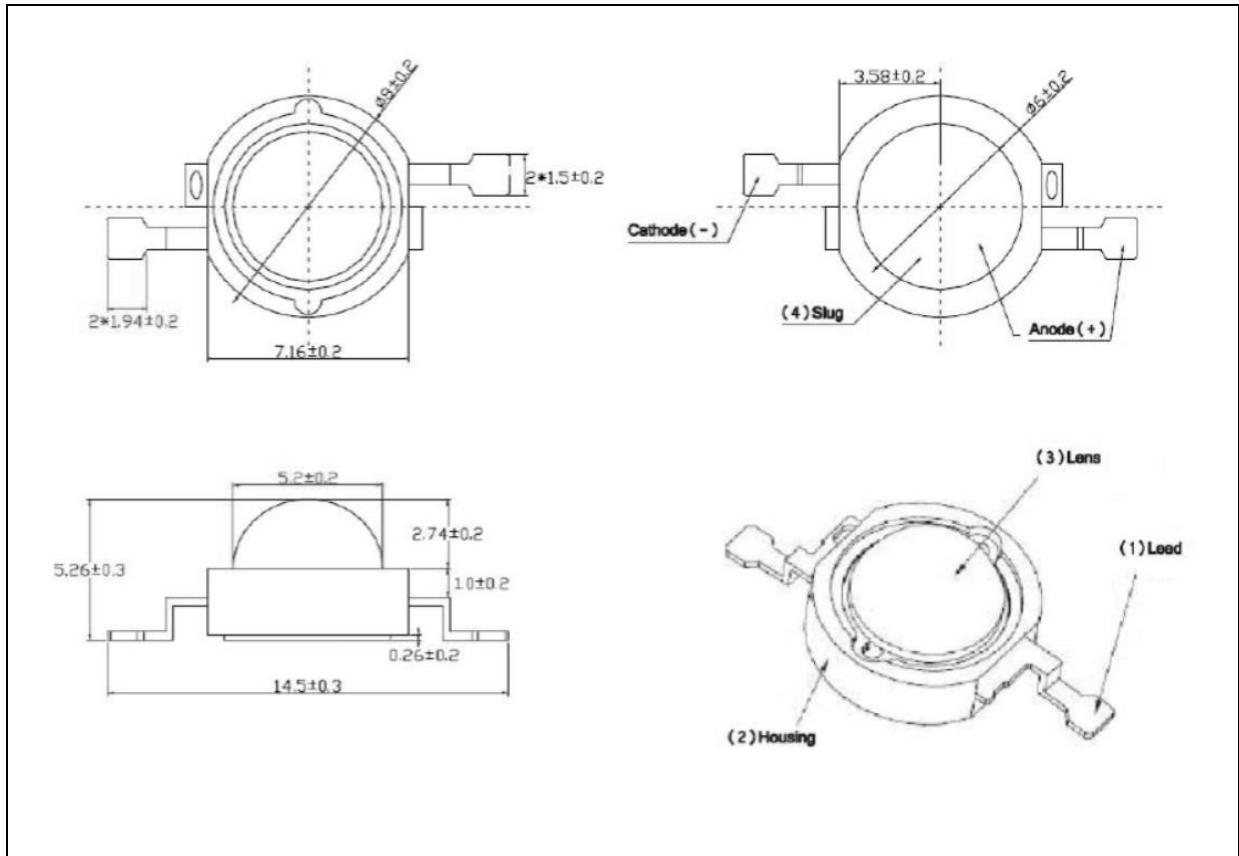
### Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test Condition
		Min.	Typ.	Max.		
Forward Voltage	$V_F$	2.8	3.2	3.6	V	$I_F=350mA$
Luminous Flux	$\Phi_v$	18	40	---	lm	$I_F=350mA$
Dominant Wavelength	$\lambda_d$	460	---	470	nm	$I_F=350mA$
Viewing Angle	$2\theta_{1/2}$	---	155	---	deg	$I_F=350mA$

1. Luminous intensity (lv)  $\pm 15\%$ , Forward Voltage ( $V_f$ )  $\pm 0.1V$ , Viewing angle( $2\theta_{1/2}$ )  $\pm 5\%$

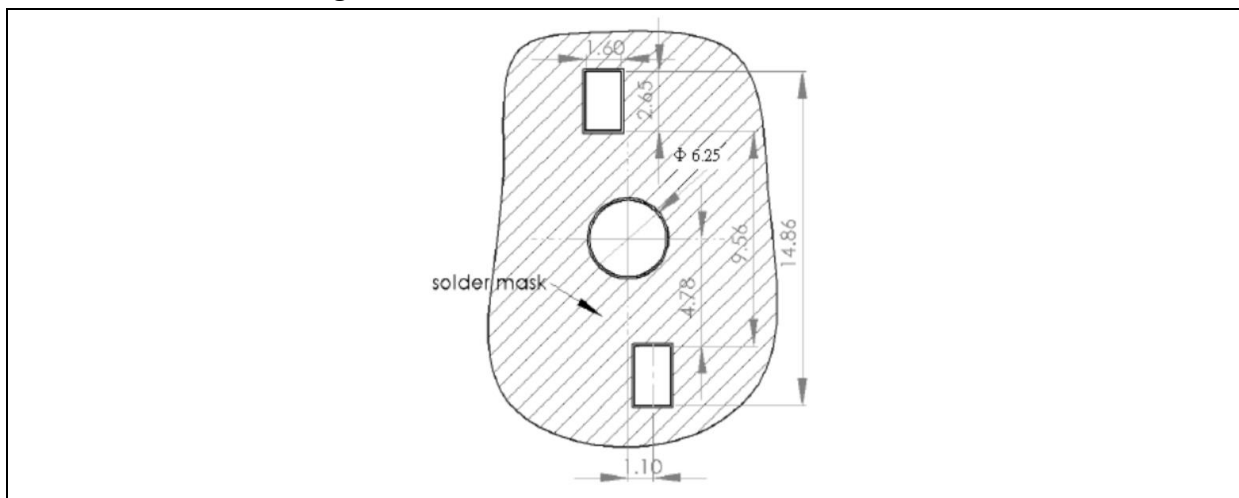
## OUTLINE DIMENSION:

Package Dimension:



1. All dimensions are in millimetre (mm).
2. Tolerance  $\pm 0.1$ mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).
2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^\circ$ .

**BINNING GROUPS:**


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 Forward Voltage Classifications ( $I_F = 350\text{mA}$ ):

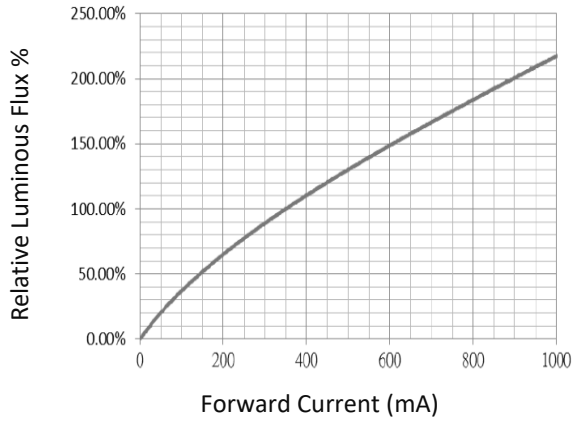
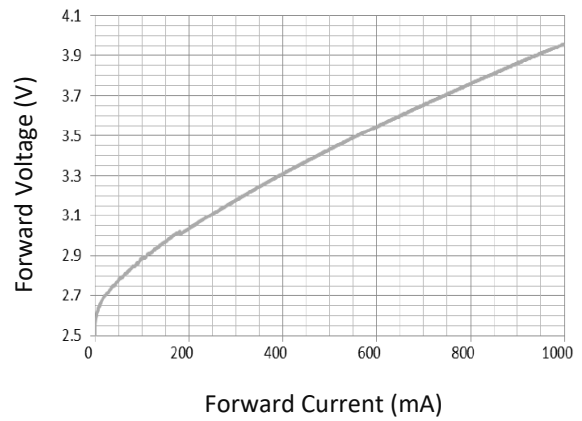
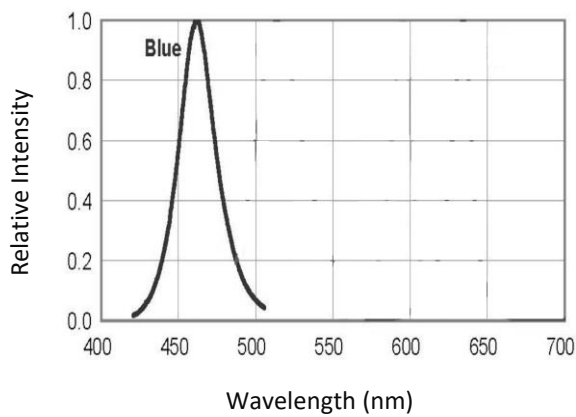
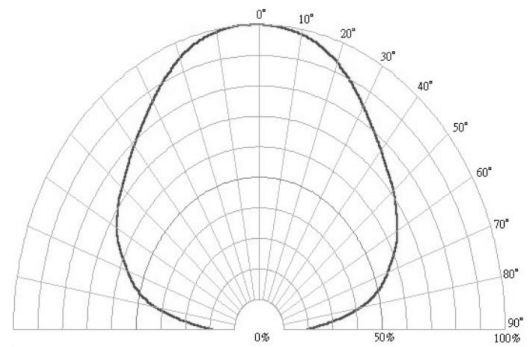
Code	Min.	Max.	Unit
1	2.8	2.9	V
2	2.9	3.0	
3	3.0	3.1	
4	3.1	3.2	
5	3.2	3.3	
6	3.3	3.4	
7	3.4	3.5	
8	3.5	3.6	

 Luminous Flux Classifications ( $I_F = 350\text{mA}$ ):

Code	Min.	Max.	Unit
12	15	20	lm
13	20	25	
14	25	30	
15	30	35	
16	35	40	
17	40	45	
18	45	50	
19	50	55	

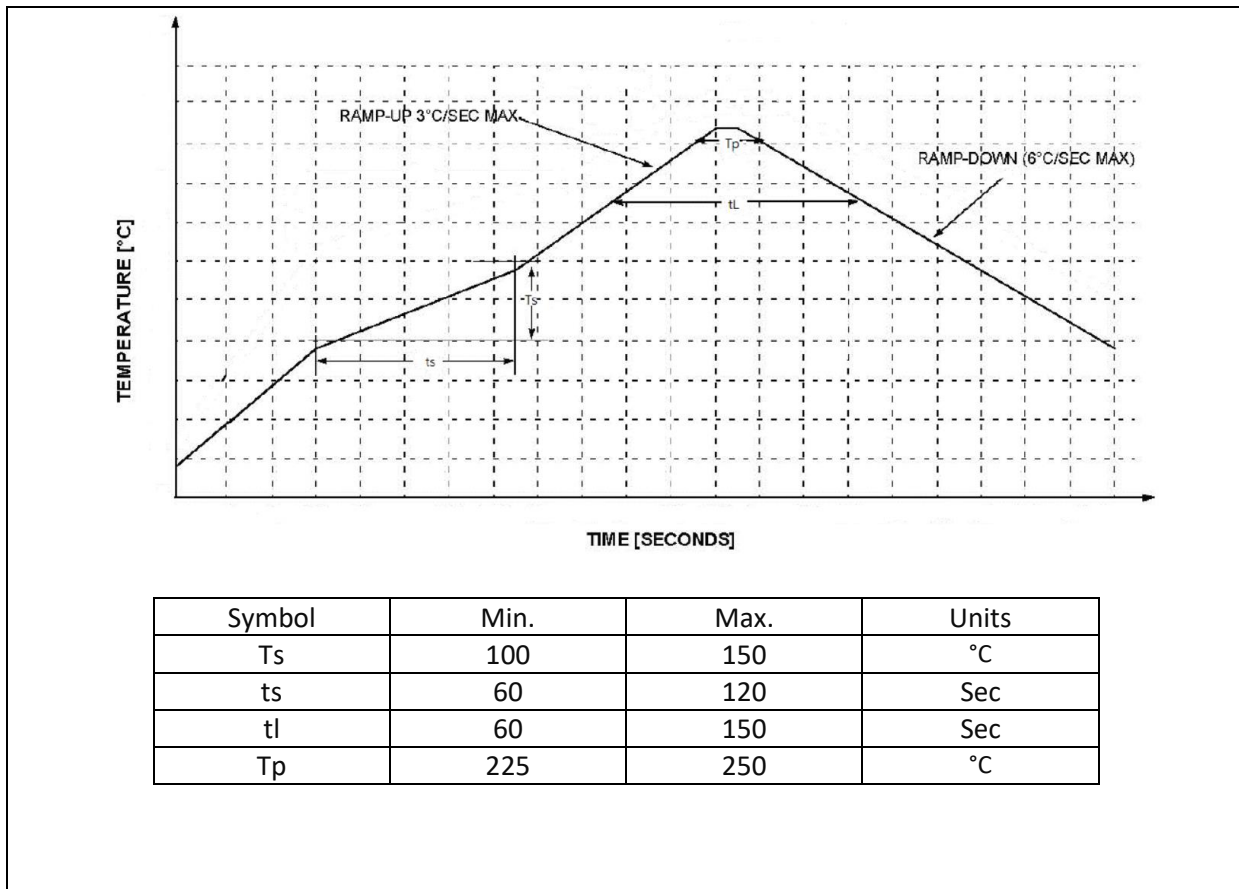
 Wavelength Classifications ( $I_F = 350\text{mA}$ ):

Code	Min.	Max.	Unit
B1	460	465	nm
B2	465	470	

**ELECTRO-OPTICAL CHARACTERISTICS:**
**Relative Luminous Flux v.s. Forward Current**

**Forward Current v.s. Forward Voltage**

**Relative Intensity v.s. Wavelength**

**Directive Radiation**


## RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:

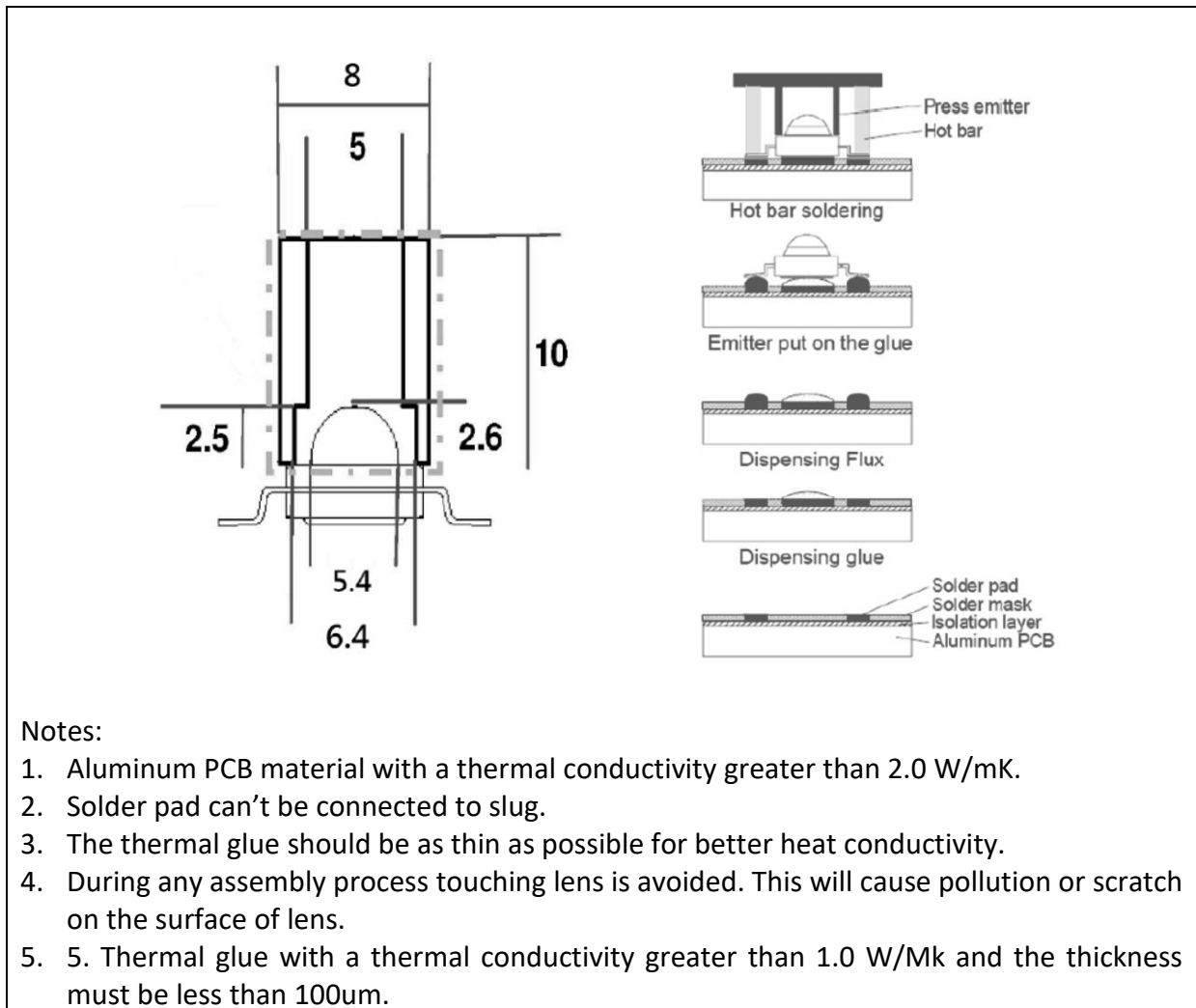


Note:

1. Maximum reflow soldering: 1 time.
2. Before, during, and after soldering, should not apply stress on the components and PCB board.

## RECOMMENDED NOZZLE SETTING:

Nozzle Size:

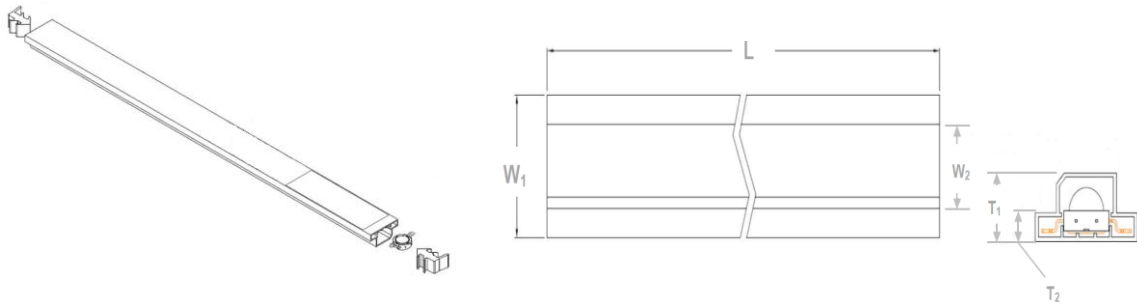


**PACKING SPECIFICATION:**

Tube Dimension:

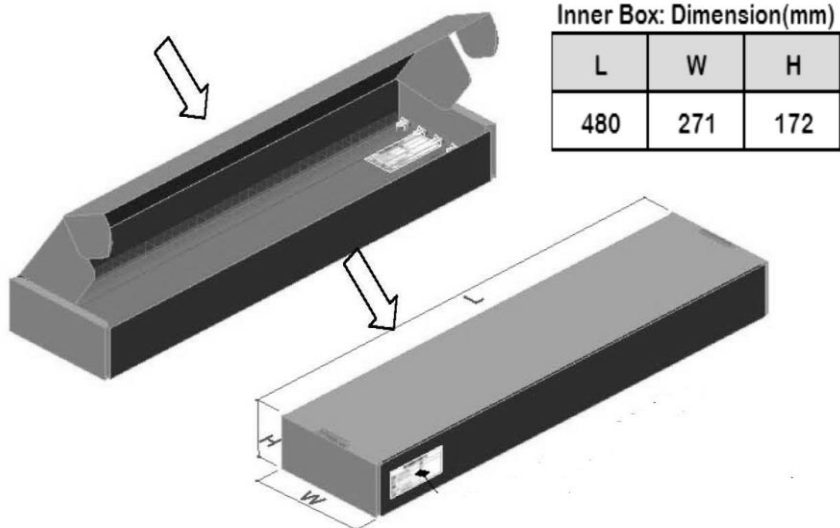
**NOB06S20**

2000pcs/carton (40 tubes); 50pcs/tube



Unit(mm)

W <sub>1</sub>	W <sub>2</sub>	T <sub>1</sub>	T <sub>2</sub>	L
16.5	9.7	7.9	3.3	420



Inner Box: Dimension(mm)

L	W	H
480	271	172

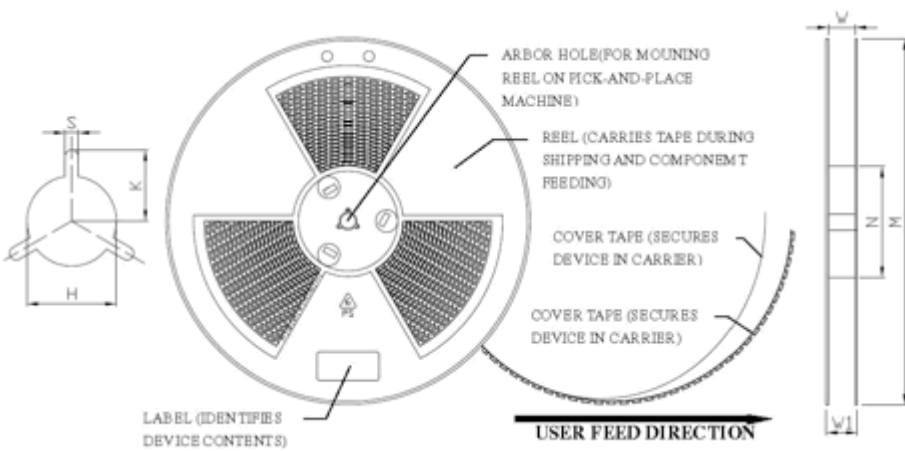


**PACKING SPECIFICATION:**

Reel Dimension:

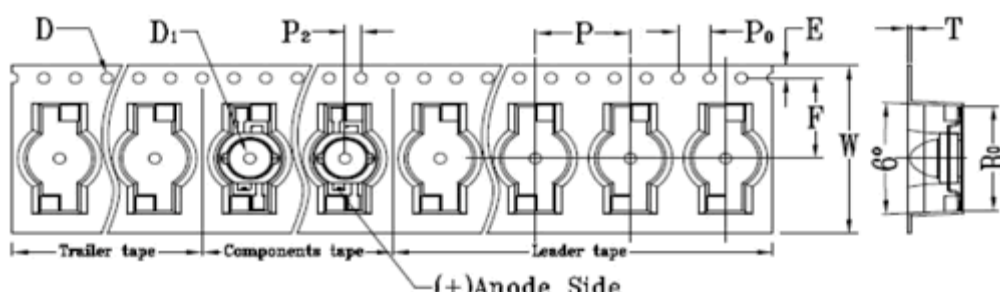
**N0B06S20RL**

1000pcs/reel



Unit: mm

M	N	W	W1	H	K	S
Φ330.0	Φ99.5	24.4	29	Φ13.5	10.75	2.5
±1.0	±1.0	±1.0	±1.0	±0.5	±0.5	±0.5

Unit: mm

W	P	E	F	P <sub>2</sub>	D	D <sub>1</sub>	P <sub>0</sub>	A <sub>0</sub>	B <sub>0</sub>	K <sub>0</sub>	T
24.0	12.0	1.75	11.5	2.0	1.5	1.5	4.0	8.2	15.0	6.7	0.4
±0.3	±0.1	±0.1	±0.1	±0.1	±0.1	±0.25	±0.1	±0.1	±0.1	±0.1	±0.05

## PRECAUTIONS OF USE:

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### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with desiccating agent and apply baking.

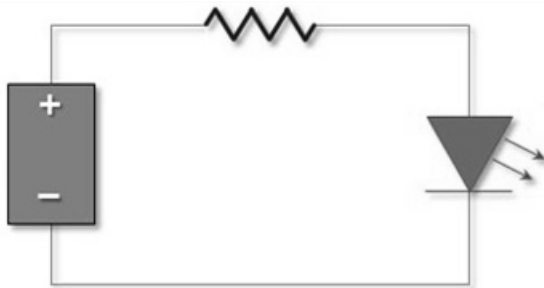
### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 60±3°C x 12hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

### Testing Circuit:



Must apply resistor(s) for protection (over current proof).

### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

**REVISION RECORD:**

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Version	Date	Summary of Revision
A1.0	14/04/2014	Datasheet set-up.
A1.1	27/05/2014	Add reel packing information.
A1.2	27/05/2019	Revise bin table.